

A Product Line of **Diodes Incorporated**



SPECIFICATION FOR APPROVAL

CUSTOMER

NOMINAL FREQUENCY

27.000000 MHz

PRODUCT TYPE

TYPE FH 2.5x2.0 SEAM SEALED CRYSTAL

FH2700005

SPEC. NO. (P/N)

CUSTOMER P/N

ISSUE DATE

VERSION

January 9, 2018

С

APPROVED	PREPARED	QA
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*Pb-free

- *RoHS Compliant
- *HF-Halogen Free
- *REACH Compliant

TYPE FH 2.5x2.0 SEAM SEALED CRYSTAL

FH2700005

VER. C 9-Jan-18

VERSION HISTORY

Version No.	Version Date	Description	Notes
А	Nov.19,2008	Initial Release	
В	Feb.22,2011	Revised format & Changed Logo	
С	Jan.9,2018	Updated logo	



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ELECTRICAL SPECIFICATIONS

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	27.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Calibration Load Capacitance	CL	12	pF	
Calibration Tolerance	FL	±10	ppm	at 25°C±3°C
Operating Temperature Range	TR	-20 to +70	°C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±10	ppm	Reference to the Frequency at 25°C
Operating Drive Level		10	μW	
Maximum Drive Level		100	μW	
Equivalent Series Resistance	ESR	80	Ω	Max
Shunt Capacitance	C0	5	pF	Max
Aging at 25°C		±5	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	MΩ	Min

* This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).



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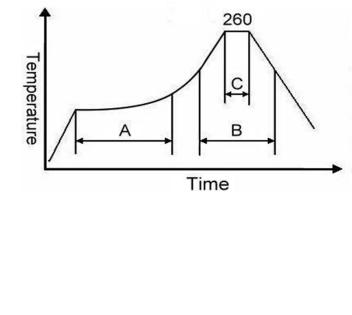
RELIABILITY SPECIFICATIONS

MECHANICAL AND ENVIRONMENTAL RATINGS:

- a) FINE LEAK TEST: JESD22-A109 (Condition 1A)
- b) GROSS LEAK TEST: JESD22-A109 (Condition C)
- c) MOISTURE RESISTANCE: JESD22-A113
- d) SHOCK: JESD22-B104 (Condition B)
- e) SOLDERABILITY : (RoHS version): J-STD-002
- f) VIBRATION: JESD22-B103
- g) SOLVENT RESISTANCE: JESD22-B107
- h) RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

SUGGESTED IR REFLOW PROFILE

*As per IPC-JEDEC J-STD-020D



Note:							
Stage	Temperature	Time					
Preheat	150~200°C	60~120 Sec					
Primary Heat	217°C	60~150 Sec					
Peak	260°C	10 Sec					
	Stage Preheat Primary Heat	Stage Temperature Preheat 150~200°C Primary Heat 217°C					



